MAGX-002731-180L00





GaN HEMT Pulsed Power Transistor 2.7 - 3.1 GHz, 180W Peak, 300us Pulse, 10% Duty

Production V1 27 Sept 11

Features

- GaN depletion mode HEMT microwave transistor
- Common source configuration
- Broadband Class AB operation
- Thermally enhanced Cu/Mo/Cu package
- **RoHS Compliant**
- +50V Typical Operation
- MTTF of 114 years (Channel Temperature < 200°C)
- **EAR99 Export Classification**

Application

Civilian and Military Pulsed Radar



Product Description

The MAGX-002731-180L00 is a gold metalized matched Gallium Nitride (GaN) on Silicon Carbide RF power transistor optimized for civilian and military radar pulsed applications between 2700 - 3100 MHz. Using state of the art wafer fabrication processes, these high performance transistors provide high gain, efficiency, bandwidth, ruggedness over a wide bandwidth for today's demanding application needs. The MAGX-002731-180L00 is constructed using a thermally enhanced Cu/Mo/Cu flanged ceramic package which provides excellent thermal performance. High breakdown voltages allow for reliable and stable operation in extreme mismatched load conditions unparalleled with older semiconductor technologies.

Typical Peak RF Performance

50\/ 300us 10%

30 V, 300ds, 10 %						
Freq	Pin	Pout	Gain	Flat	Eff	Droop
(MHz)	(Wpk)	(Wpk)	(dB)	(dB)	(%)	(dB)
2700	14	193.6	11.4	-	48.9	0.45
2800	14	208.0	11.7	-	48.6	0.43
2900	14	199.3	11.5		45.8	0.44
3000	14	199.3	11.5		47.7	0.45
3100	14	185.8	11.2	0.52	47.5	0.41

50V. 500us. 10%

Freq	Pin	Pout	Gain	Flat	Eff	Droop
(MHz)	(Wpk)	(Wpk)	(dB)	(dB)	(%)	(dB)
2700	14	198.2	11.5		50.4	0.58
2800	14	213.1	11.8		49.9	0.55
2900	14	203.2	11.6		46.8	0.58
3000	14	201.2	11.6		48.8	0.53
3100	14	183.2	11.2	0.65	48.3	0.53

Typical RF performance measured in M/A-COM RF test fixture. Devices tested in common source Class-AB configuration as follows: Vdd=50V, Idq=500mA (pulsed gate bias), F=2.7- 3.1 GHz, Pulse Width=300ms, Duty=10%.

Ordering Information

MAGX-002731-180L00 MAGX-002731-SB3PPR

able. Commitment to produce in volume is not guaranteed.

180W GaN Power Transistor **Evaluation Fixture**

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Absolute Maximum Ratings Table (1, 2, 3)

+65V
-8 to 0V
10A
+36 dBm
200 °C
192 W
0.6 °C/W
-40 to +95C
-65 to +150C
See solder reflow profile
50 V
>250 V
MSL1

⁽¹⁾ Operation of this device above any one of these parameters may cause permanent damage.

Parameter	Test Conditions	Symbol	Min	Тур	Max	Units	
DC CHARACTERISTICS	DC CHARACTERISTICS						
Drain-Source Leakage Current	V _{GS} = -8V, V _{DS} = 175V	I _{DS}	-	-	12	mA	
Gate Threshold Voltage	$V_{DS} = 5V$, $I_D = 30mA$	V _{GS (th)}	-5	-3	-2	V	
Forward Transconductance	$V_{DS} = 5V, I_{D} = 3.5 mA$	G_{M}	5.0	-	-	S	
DYNAMIC CHARACTERISTICS							
Input Capacitance	Not applicable - Input internally matched	C_GS	N/A	N/A	N/A	pF	
Output Capacitance	$V_{DS} = 50V, \ V_{GS} = -8V, F = 1MHz$	Coss	-	26.1	30.3	pF	
Reverse Transfer Capacitance	ce $V_{DS} = 50V, V_{GS} = -8V, F = 1MHz$		-	2.3	4.7	pF	

⁽²⁾ Channel temperature directly affects a device's MTTF. Channel temperature should be kept as low as possible to maximize lifetime.

⁽³⁾ For saturated performance it recommended that the sum of (3*Vdd + abs(Vgg)) <175

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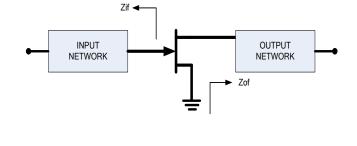
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Electrical Specifications: T_C = 25 ± 5°C (Room Ambient)

Parameter	Test Conditions	Symbol	Min	Тур	Max	Units
RF FUNCTIONAL TESTS Vdd=50V, Idq=500mA (pulsed gate bias), F=2.7- 3.1 GHz, Pulse Width=300ms, Duty=10%.						
Output Power	Pin = 14W Peak, 1.4W Ave	P _{OUT}	180 18	190 19	-	W Peak W Ave
Power Gain	Pout = 180W Peak, 18W Ave	G _P	10.5	11.5	-	dB
Drain Efficiency	Pin = 14W Peak, 1.4W Ave	η_{D}	43	50	-	%
Load Mismatch Stability	Pin = 14W Peak, 1.4W Ave	VSWR-S	5:1	-		-
Load Mismatch Tolerance	Pin = 14W Peak, 1.4W Ave	VSWR-T	10:1	-		-

Test Fixture Impedance

Freq	Zif	Zof		
2.7	2.04 - j 5.75	2.82 - j 2.00		
2.8	1.61 - j 5.40	3.08 - j 2.73		
2.9	1.28 - j 4.98	2.88 - j 3.30		
3.0	1.13 - j 4.51	2.49 - j 3.49		
3.1	1.19 - j 4.18	2.21 - j 3.64		



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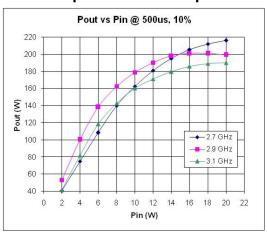
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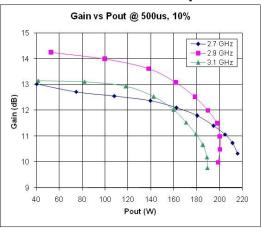
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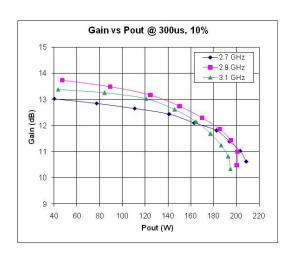
RF Power Transfer Curve Peak Output Power vs. Input Power



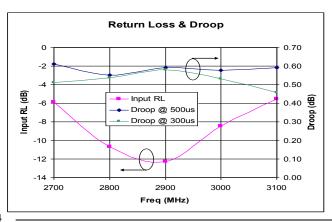
Pout vs Pin @ 300us, 10% 220 200 180 160 **2** 140 **철** 120 100 -2.7 GHz - 2.9 GHz 80 ▲ 3.1 GHz 60 10 12 14 16 18 20 22 0 2 4 8 Pin (W)

RF Power Transfer Curve Power Gain vs. Peak Output Power





Input VSWR & Droop (Typ)



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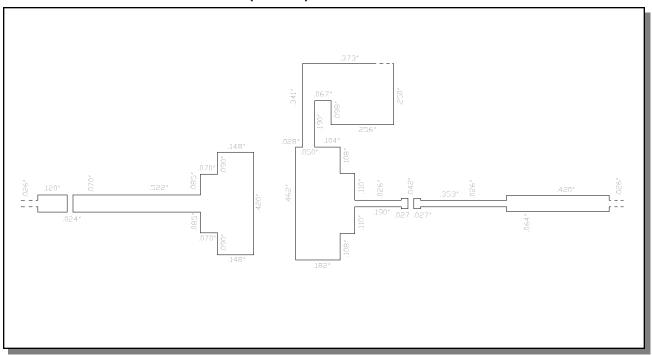
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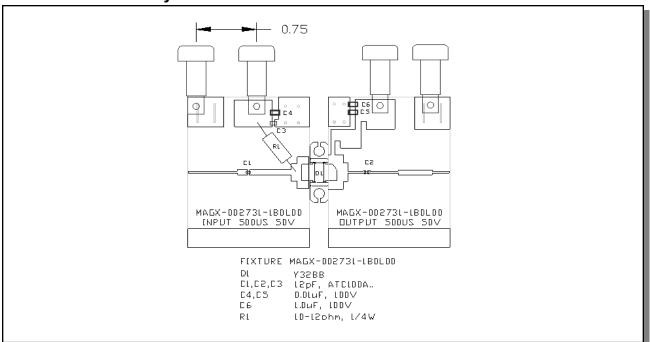
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Test Fixture Circuit Dimensions (inches)



Test Fixture Assembly



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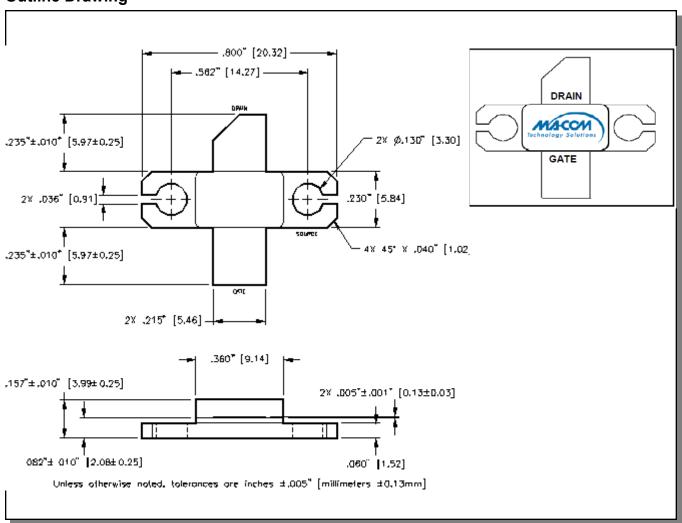
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Outline Drawing



CORRECT DEVICE SEQUENCING

TURNING THE DEVICE ON

- 1. Set V_{GS} to the pinch-off (V_P) , typically -5V
- 2. Turn on V_{DS} to nominal voltage (50V)
- 3. Increase V_{GS} until the I_{DS} current is reached
- 4. Apply RF power to desired level

TURNING THE DEVICE OFF

- 1. Turn the RF power off
- 2. Decrease V_{GS} down to V_P
- 3. Decrease V_{DS} down to 0V
- 4. Turn off V_{GS}

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